SP	FC	IFI	CA ₁	ΓΙΩ	NS
J					140

CUSTOMER . CDE030

SAMPLE CODE . SE12864LRF-042-H-Q

MASS PRODUCTION CODE PE12864LRF-042-H-Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 003

DRAWING NO. (Ver.) - HLMD-PE12864LRF-042-H-Q_001

PACKAGING NO. (Ver.) : HPKG-PE12864LRF-042-H-Q_001

Customer Approved

Date:

Approved	Checked	Designer
王剛/張慶源	詹漢華	黃杰峰/魏永超 POWERTIP

Preliminary specification for design input

Specification for sample approval

POWERTIP TECH. CORP.

Headquarters: No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: sales@powertip.com.tw

2009.03.27 HK RD APR

Http://www.powertip.com.tw



RECORDS OF REVISION

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
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11/11/2008	01	002	First Sample		黃杰峰
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Appendix: 1. LCM Drawing

2. Packing Specification



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	128*64 Dots
LCD Type	FSTN, Positive, Transflective, Extended Temperature
Driver Condition	LCD Module: 1/65 Duty, 1/9 Bias
Viewing Direction	6 O'clock
Backlight	Yellow-Green LED B/L
Weight	29.4 g
Interface	4-line serial interface
Other(controller / driver IC)	ST7567
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

1.2 Mechanical Specifications

Item	Standard Value	
Outline Dimension	80.0(L) *54.0(w) (except FPC length) * 9.7(H)	mm
Viewing Area	70.7 (W) * 38.8 (L)	
Active Area	66.545(W) *33.265 (L)	mm
Dot Size	0.505 (W) * 0.505 (L)	
Dot Pitch	0.52(W) * 0.52 (L)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	VDD		-0.3	3.6	V
LCD Driver Supply Voltage	V0-XV0	_	-0.3	16	V
Operating Temperature	T _{OP}	_	-20	70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	_	-30	+80	$^{\circ}\!\mathbb{C}$
Storage Humidity	H_D	Ta < 60 °C	-	90	%RH



1.4 DC Electrical Characteristics

 $V_{SS} = 0V$, Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	VDD	-	2.7	3.0	3.3	V
"H" Input Voltage	V_{IH}	-	0.7 VDD	1	VDD	V
"L" Input Voltage	$V_{ m IL}$	-	VSS	1	0.3VDD	V
"H" Output Voltage	V_{OH}	I _{OUT} =1mA,VDD=3.0V	0.8VDD	ľ	VDD	V
"L" Output Voltage	$ m V_{OL}$	I _{OUT} =-1mA,VDD=3.0V	Vss	-	0.2 VDD	V
Complex Comment	ī	V _{DD} =3.0V;V _{OP} =8.5V; Pattern= Full display	-	0.31	2	A
Supply Current	$ m I_{dd}$	V _{DD} =3.0V;V _{OP} =8.5V; Pattern= Horizontal line*1	-	0.75	1.5	mA
		-20°C	8.5	8.7	8.9	
LCM Driver Voltage	V _{OP} *2	25℃	8.3	8.5	8.7	V
		70℃	8.2	8.4	8.6	

NOTE: *1 The Maximum current display;

*2 The VOP test point is the capacitance of C10.





1.5 Optical Characteristics

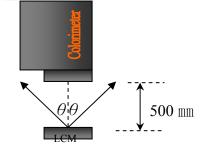
LCD Panel: 1/65Duty, 1/9Bias, $V_{LCD} = 8.5$ V, Ta = 25°C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr		-	100	150	mg	Note2
Response Time	Fall	tf		-	250	375	ms	Notez
	Тор	ΘY+ C≥2.0,		-	- (40		
Viewing angle	Bottom OY-		Ø = 270°	-	-	40	Dag	Notes 1
range	Left	ΘX-		-	/-	45	Deg.	Notes 1
	Right	ΘХ+		-	(-)	45		
Contrast Ratio		С	$\theta = 0^{\circ},$ $\emptyset = 270^{\circ}$	2	4	ì	-	Note 3
Average Brightness (with LCD) *2		IV		2.5	3.0	-	cd/m ²	
Wavelength		Hue	IF=80mA	569	571	576	nm	Note 4
Uniformity '	*1	△B		70	-	-	%	

Note 4

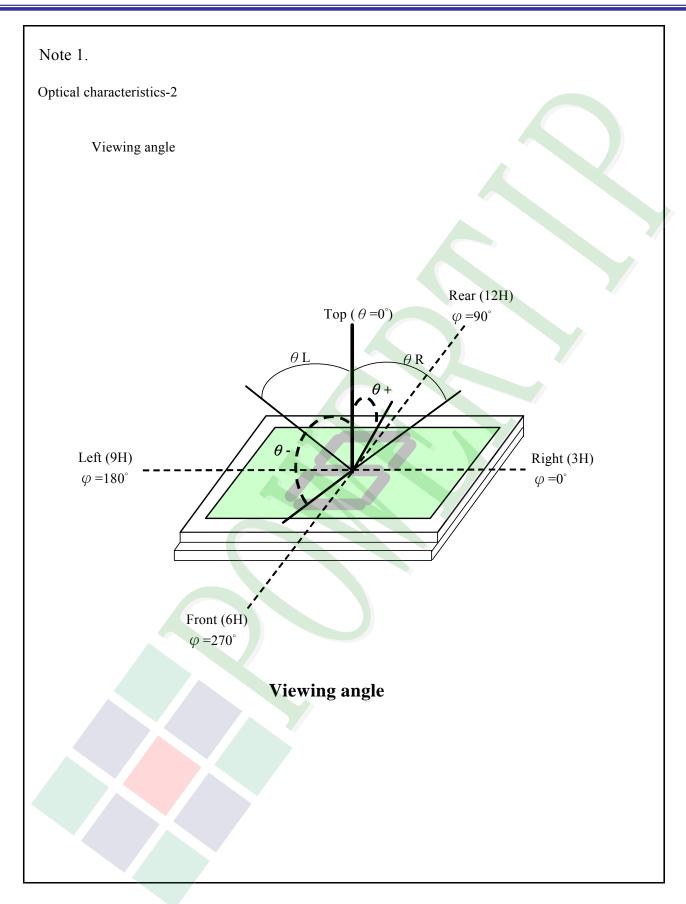
- $1 : \triangle B = B(min) / B(max) * 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b: Measurement Distance: 500 ± 50 mm $\theta = 0^{\circ}$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



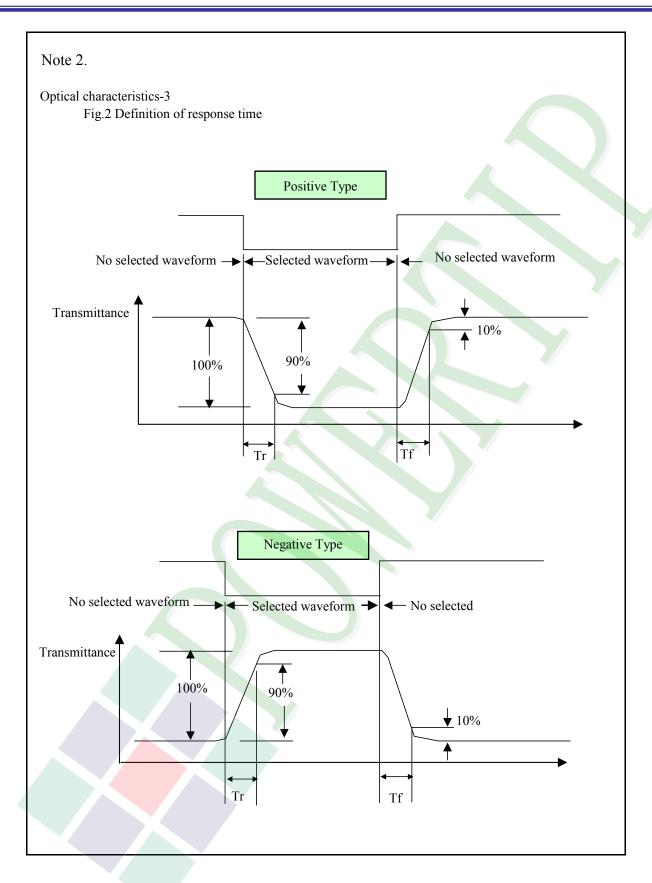


Colorimeter=BM-7 fast











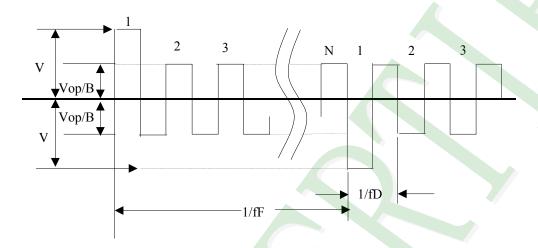
Electrical characteristics-2

※2 Drive waveform

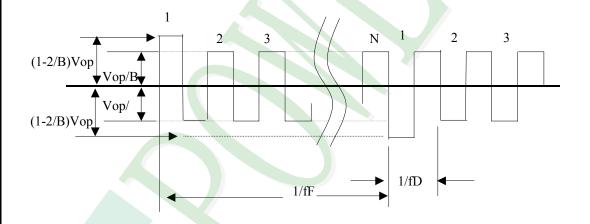
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



(2) Non- Selected wave form

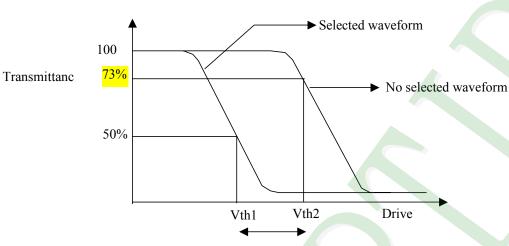


Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period







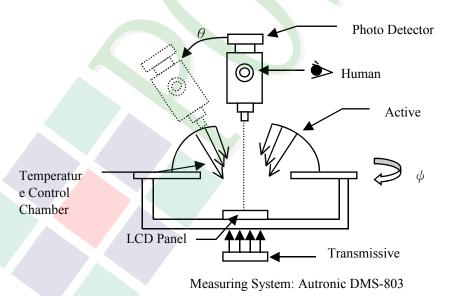
Active voltage range

_	Vth1	Vth2
View direction	10°	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





1.6 Backlight Characteristics

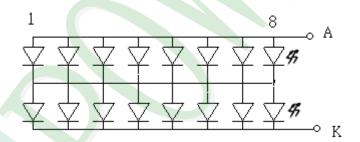
LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Ratings	Unit
Forward Current	IF	Ta =25°C	80	mA
Power Dissipation	PD	Ta =25°C	336	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=80mA	-	4.2	4.6	V
Average Brightness (without LCD)	IV	IF=80mA	9.6	12.0	_	cd/m ²
Color		YELI	LOW-GRI	EEN		





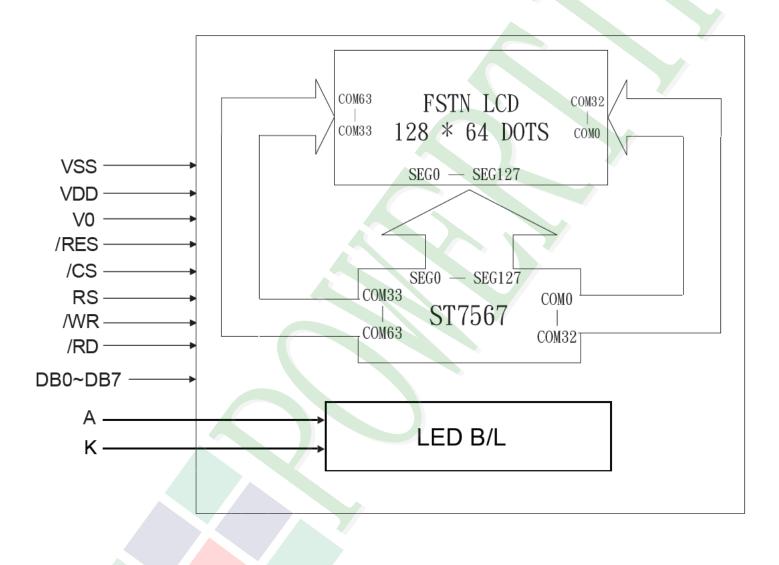
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





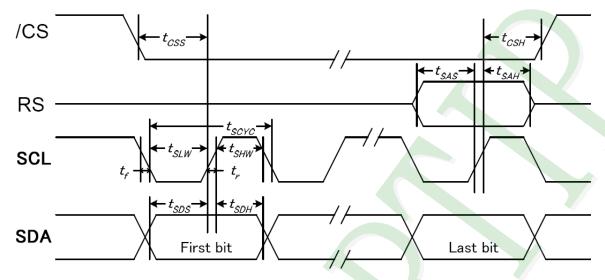
2.2 Interface Pin Description

Pin No.	Symbol	Function
1	VSS	Power Supply (VSS=0)
2	VDD	Power Supply (VDD>VSS)
3	V0	NO Connection
4	/RES	Controller reset (module reset)
5	/CS	Used to enter chip select signal
6	RS	Select control data or display data for read/write operation "L"=control data "H"=display data
7	/WR	Must be connected to VDD
8	/RD	Must be connected to VDD
9	DB0	Must be connected to VDD
10	DB1	Must be connected to VDD
11	DB2	Must be connected to VDD
12	DB3	Must be connected to VDD
13	DB4	Must be connected to VDD
14	DB5	Must be connected to VDD
15	DB6(SCL)	Serial data input
16	DB7(SDA)	serial clock input
17	A	Power supply LED backlight(+)
18	K	Power supply LED backlight(-)



2.3 Timing Characteristics

System Bus Timing for 4-Line Serial Interface



(VDD = 3.3V , Ta =-30~85°C)

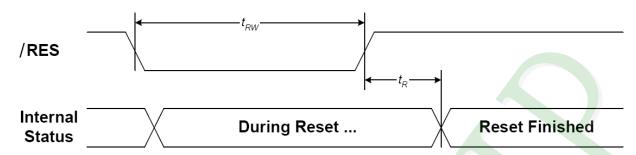
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		50	_	
SCLK "H" pulse width	SCL	tSHW		25	_	
SCLK "L" pulse width		tSLW		25	_	
Address setup time	RS	tSAS		20	_	
Address hold time	No	tSAH		10	_	ns
Data setup time	SDA	tSDS		20	_]
Data hold time	SDA	tSDH		10	_	
CSB-SCLK time	ICS	tCSS		20	_	
CSB-SCLK time	/CS	tCSH		40	_	

(VDD = 2.8V , Ta =-30~85°C)

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		100	_	
SCLK "H" pulse width	SCL	tSHW		50	_	
SCLK "L" pulse width		tSLW		50	_	
Address setup time	RS	tSAS		30	_	
Address hold time	No	tSAH		20	_	ns
Data setup time	SDA	tSDS		30	_	
Data hold time	SDA	tSDH		20	_	
CSB-SCLK time	/CS			30	_	
CSB-SCLK time	703	tCSH		60	_	



Hardware Reset Timing



 $(VDD = 3.3V, Ta = -30 \sim 85^{\circ}C)$

Item	Symbol	Condition	Min.	Max.	Unit
Reset time	tR		_	1.0	
Reset "L" pulse width	tRW		1.0		us

(VDD = 2.8V , Ta =-30~85°C)

Item	Symbol	Condition	Min.	Max.	Unit
Reset time	tR		-	2.0	
Reset "L" pulse width	tRW		2.0	_	us





2.4 Display command

INSTRUCTION AS R/W COMMAND BYTE					DESCRIPTION						
INSTRUCTION	A0	(RWR)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
(1) Display ON/OFF	0	0	1	0	1	0	1	1	1	D	D=1, display ON D=0, display OFF
(2) Set Start Line	0	0	0	1	S5	S4	S3	S2	S1	S0	Set display start line
(3) Set Page Address	0	0	1	0	1	1	Y3	Y2	Y1	Y0	Set page address
(4)	0	0	0	0	0	1	X7	X6	X 5	X4	Set column address (MSB)
Set Column Address	0	0	0	0	0	0	Х3	X2	X1	X0	Set column address (LSB)
(5) Read Status	0	1	0	MX	D	RST	0	0	0	0	Read IC Status
(6) Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write display data to RAM
(7) Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read display data from RAM
(8) SEG Direction	0	0	1	0	1	0	0	0	0	MX	Set scan direction of SEG MX=1, reverse direction MX=0, normal direction
(9) Inverse Display	0	0	1	0	1	0	0	1	1	INV	INV =1, inverse display INV =0, normal display
(10) All Pixel ON	0	0	1	0	1	0	0	1	0	AP	AP=1, set all pixel ON AP=0, normal display
(11) Bias Select	0	0	1	0	1	0	0	0	1	BS	Select bias setting 0=1/9; 1=1/7 (at 1/65 duty)
(12) Read-modify-Write	0	0	1	1	1	0	0	0	0	0	Column address increment: Read:+0 , Write:+1
(13) END	0	0	1	1	1	0	1	1	1	0	Exit Read-modify-Write mode
(14) RESET	0	0	1	1	1	0	0	0	1	0	Software reset
(15) COM Direction	0	0	1	1	0	0	MY	·	-	-	Set output direction of COM MY=1, reverse direction MY=0, normal direction
(16) Power Control	0	0	0	0	1	0	1	VB	VR	VF	Control built-in power circuit ON/OFF
(17) Regulation Ratio	0	0	0	0	1	0	0	RR2	RR1	RR0	Select regulation resistor ratio
(18) Set EV	0	0	1	0	0	0	0	0	0	1	Double command!! Set
(10) Set LV	0	0	0	0	EV5	EV4	EV3	EV2	EV1	EV0	electronic volume (EV) level
40.0.40	0	0	1	1	1	1	1	0	0	0	Double command!!
(19) Set Booster	0	0	0	0	0	0	0	0	BL1	BL0	Set booster level: 00=4X, 01=5X, 10=6X
(20) Power Save	0	0			Cor	mpound	Comm	and			Display OFF + All Pixel ON
(21) NOP	0	0	1	1	1	0	0	0	1	1	No operation
(22) Test	0	0	1	1	1	1	1	1	1	-	Do NOT use. Reserved for testing.

Note: Symbol "-" means this bit can be "H" or "L".

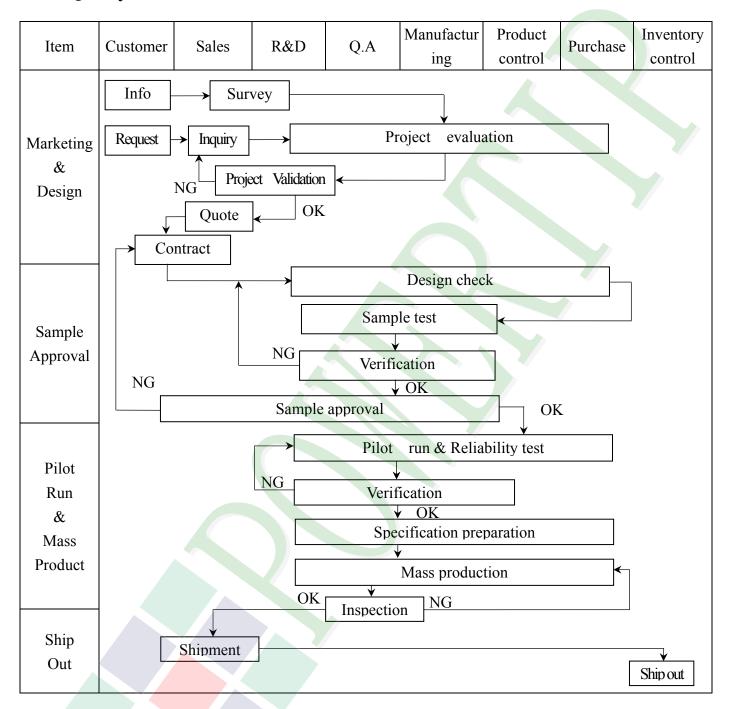
2.5 Jumper

J1(2.3)/J2(2.3)/J3(2.3)/J6:SHORT;OTHER:OPEN

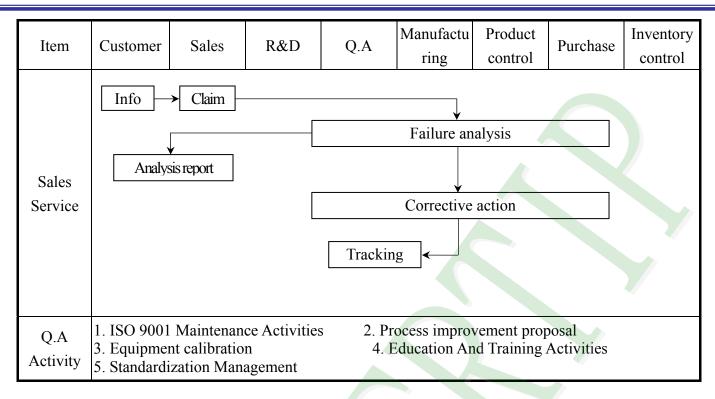


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN (Ver. 03).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- ◆OUT Going Defect Level: Sampling.
- ◆Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area. (Fig. 2)

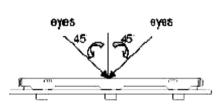


Fig.1

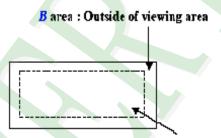


Fig. 2 A area: viewing area

♦ Specification:

NO	Item	Criterion	level
	1, 1 The part number is inconsistent with work order of Production.		Major
01	Product condition	1. 2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
04	Electrical Testing	4. 2 No function or no display.	Major
		4, 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major



◆Specification For Monotype and Color STN:

(Yer. 03)

- -		otype and Color STN:	'ritorio	239		Ver. 03)	
NO 05	Item Black or white dot · scratch · contamination Round type A Y Y Y D = (x+y)/2 Line type		Acce	level			
	✓ ÅW L ►	→ L ←	$\begin{array}{c cccc} & & & & & & & & & & & & & & & & & $	0. 0 5 07 5	Accept no dens	Ignore	
		" " >0	. טוט	ASTO	und type		
		Dimension (diameter: Φ)		Acceptance A area	(Q'ty) B area		
		Φ ≤ 0 . 20		cept no dense			
06	Polarizer	$0.20 < \Phi \leq 0.50$		3]	Minor	
	Bubble	0.50 < Φ ≤ 1.00		2	Ignore		
		Φ > 1.00		0]		
		Total quantity	4				



◆Specification For Monotype and Color STN: (Yer. 03)

NO	Item	Criter	ion	Leve
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass	Y : The width of crack. W : terminal length a : LCD side length	
		7. 1 General glass chip: 7. 1. 1 Chip on panel surface and contact and contact are also as a surface and contact are a sur	rack between panels:	
07	The crack of glass	SP—	SP	Mine
		Seal width	[NG]	
		X Y	z	
		≦ a Crack can't ente viewing area	r ≤1/2 t	
		≤ a Crack can't exceed half of SP width		



◆Specification For Monotype and Color STN: (Yer. 03)

Symbols: X: The length of crack Z: The thickness of crack T: The thickness of crack T: The thickness of glass $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	NO	Item	Criterion	Level
The crack of glass The crack of $\leq 1/5$ a Crack can't exceed the half of SP width. 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad: X X Y Y			X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
The crack of glass The crack of $\leq 1/5$ a Crack can't exceed the half of SP width. 7. 2 Protrusion over terminal: 7. 2. 1 Chip on electrode pad: X X Y X Y X Y X X			X Y Z	
The crack of glass 7. 2 Protrusion over terminal: 7. 2. 1 Chip on electrode pad: $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			1 1 2 1/3 9 1 1 2 2 1/2 1 1 1	
7. 2 Protrusion over terminal: 7. 2. 1 Chip on electrode pad: $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0.7	The crack of	1 5 7 9 1 1 7 7 5 7 5 7 1	N.C.
7. 2. 1 Chip on electrode pad: X X X X X X X X	ויי	glass	7.2 Protrusion over terminal:	Minor
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
$\begin{array}{c cccc} X & Y & Z \\ \hline Front & \leq a & \leq 1/2 \text{ W} & \leq t \\ \end{array}$			W Y X	
Front ≤ a ≤ 1/2 W ≤ t			X	
			X Y Z	
Back Neglect			Front \leq a \leq 1/2 W \leq t	
			Back Neglect	



◆Specification For Monotype and Color STN:

(Ver. 03)

NO Item	Criterion	Level
	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
07 The crack glass		Minor



◆Specification For Monotype and Color STN: (Yer. 03)

NO	Item	Criterion	Level
		8. 1 Backlight can't work normally.	Major
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1. 5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in $80 \pm 2^{\circ}$ C 96 hrs				
1	Tingii Temperatare Storage Test	Surrounding temperature, then storage at normal condition 4hrs				
2	Low Temperature Storage Test	Keep in -30 ±2°C 96 hrs				
		Surrounding temperature, then storage at normal condition 4hrs				
		Keep in +60°C/90%RH duration for	96 hrs			
3	High Humidity Storage	Surrounding temperature, then storage	ge at normal condition 4hrs			
		(Excluding the polarizer)				
		Air Discharge:	Contact Discharge:			
		Apply 2 KV with 5 times	Apply 250V with 5 times			
		Discharge for each polarity +/-	discharge for each polarity +/-			
		1. Temperature Ambient:15°C ~35	$^{\circ}\!\mathbb{C}$			
		2. Humidity relative: $30\% \sim 60\%$				
4	ESD Test	3. Energy Storage Capacitance(Cs+				
		4. Discharge Resistance(Rd):330 Ω±10%				
		5. Discharge, mode of operation:				
		Single Discharge (time between successive discharges at least 1 s)				
		(Tolerance If the output voltage indic				
		$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C}$				
5	Temperature Cycling Test	(30mins) (5mins) (5	30mins) (5mins)			
	Tomportunate eyemig rest	10 Cycle				
		Surrounding temperature, then storage	ge at normal condition 4hrs			
	Will die Teil (D. 1. 1)	1. Sine wave $10 \sim 55$ HZ frequency	(1 min)			
6	Vibration Test (Packaged)	2. The amplitude of vibration :1.5 r	nm			
		3. Each direction (XYZ) duration f	for 2 Hrs			
		Packing Weight (Kg)	Drop Height (cm)			
		0 ~ 45.4	122			
		45.4 ~ 90.8	76			
7	Drop Test (Packaged)	90.8 ~ 454	61			
		Over 454	46			
		Drop direction: ×3 comer	1/1 edges /6 sides etch 1times			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

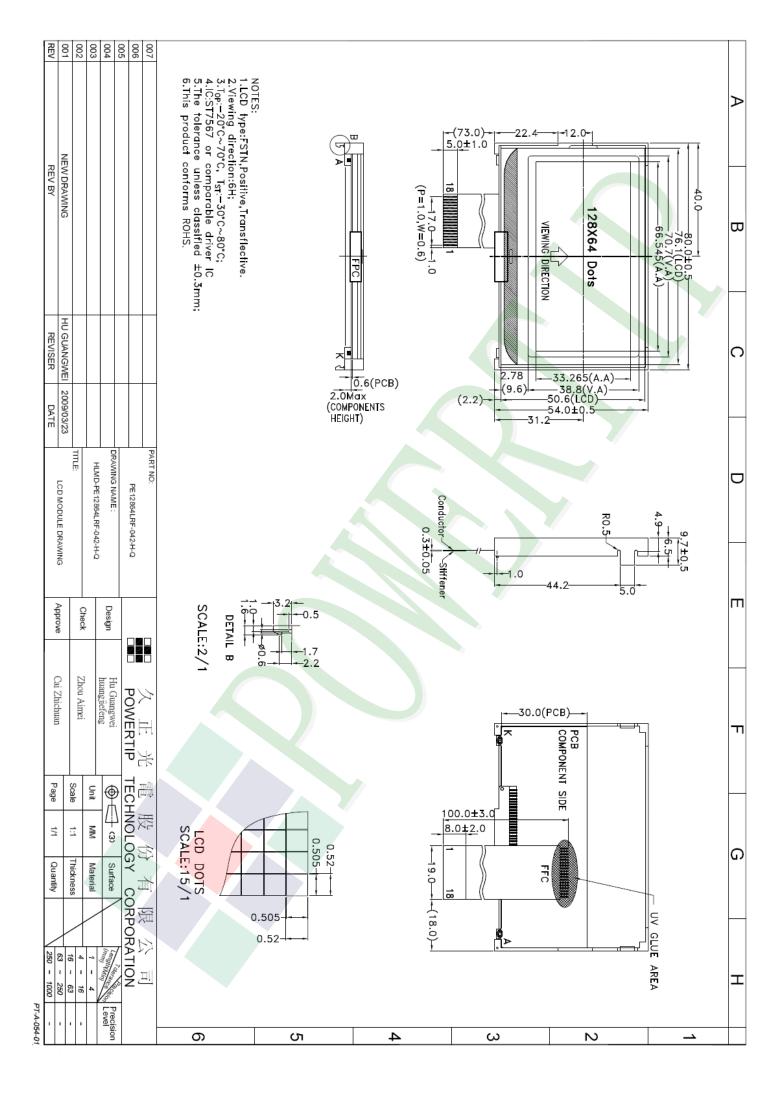
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Check Contact Approve LCM包裝規格書 Ver.001 huguangwei LCM Packaging Specifications caizhichuan zhouaimei HPKG-PE12864LRF-042-H-Q Documents NO. huang jiefeng 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PE12864LRF-042-H-Q 80.0*54.0*9.7 成品 LCM 192 5.76 1 0.03 2 靜電袋 (1)BAG 150*120*0.05 192 BAG150100ARABA 0.002 0.384 3 氣泡墊(2)BAG 192 240*100*5 BAG240100AWBBA 0.288 0.0015 4 氣泡墊(3)BAG 240*290*5 16 0.0464 BAG290240BRBBA 0.0029 5 BX29500072BZBA 0.011 104 1.144 刀卡A2(4)BX 295*72*3 0.01 0.24 6 刀卡B2(5)BX BX24500072BZBA 245*72*3 24 7 C2內盒(6)Product Box 0.221 1.768 BX31025580AABA 310*255*86 8 8 BX52532536CCBA 外紙箱(7)Carton 525*325*360 1.092 1 1.092 9 - 整箱總重量 (Total LCD Weight in carton): 10.72 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box: no. per box 12 x no. of box 2 24 (2)Total LCM quantity in carton: quantity per box x no. of boxes 192 24 8 LCM (1)靜電袋 (2) 氣泡墊: (3)氣泡墊 ſŀ ۱ĥ -(7) Carton (4)刀卡A2 (5)刀卡B2 (6)Product Box-特 記 事 項 (REMARK) 前后空一格 1. Label Specifications: MODEL: LOT NO: QUANTITY: CHECK: